IPC ASSOCIATION ELECTRONICS	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information			
upplier	Information								,					
Company name*			Company unique ID			J	Unique ID Auth			Response Date*				
nsemi											2023-06-08			
Contact Na	me		Title - Contact			I	Phone - Contact*				Email - Contact*			
Product-Ei	nv-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized	Representative*	Title - Representative			I	Phone - Representative*			Email - Representative*					
Product-E	nv-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version Manufacturing Site		Wei	ght*	UOM	Unit Type	
		NCV6356QMTWTXG Buck DCDC-0.9V		Buck DCDC-0.9V			2023-06-08 MY1		MY1	29.6	i3	mg	Each	
<b>Ianufac</b> t	turing Proccess Inform	ation												
Terminal Plating / Grid Array Material Terminal Base			erminal Base A	inal Base Alloy J-STD-020 MSL Rating			Peak Process Body Temperature   Max Time at Peak Temperature   Num					Numb	er of Reflow Cyc	les
Matte Tin (Sn) - annealed CU Alloy 1					260		C	30	seconds	3				
omments														
vel 1 - ma	ximum time at peak tempera	ture during sol	dering is 10-3	0 seconds										
or more in	nformation regarding materia	al composition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier shall apply the interest of the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.68	mg	Supplier	Silicon (Si)	7440-21-3		1.68	mg
Die Attach	0.28	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.0168	mg
			Supplier	Silver (Ag)	7440-22-4		0.2282	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.0168	mg
			Supplier	Misc.	Proprietary Data		0.0014	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.0168	mg
Lead Frame	12.8	mg	Supplier	Silver (Ag)	7440-22-4		0.256	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0154	mg
			Supplier	Iron (Fe)	7439-89-6		0.2944	mg
			Supplier	Copper (Cu)	7440-50-8		12.224	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0102	mg
Mold Compound-Black	13.17		Supplier	Epoxy resins	129915-35-1		0.6585	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.6585	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0527	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.3029	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.1945	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.3029	mg
Plating	1.05	mg	Supplier	Tin (Sn)	7440-31-5		1.05	mg
Wire Bond - Au	0.65	mg	Supplier	Gold (Au)	7440-57-5		0.65	mg